

SANYO Semiconductors

APPLICATION NOTE An ON Semiconductor Company

LV8712T / LV8713T **Bi-CMOS LSI PWM Constant-Current Control Stepping Motor Driver**

Overview

The LV8712T and LV8713T are microstepping motor drivers with built-in translator for easy operation. The LV8712T supports full-step, half-step, quarter-step, and 1/8-step resolution. The LV8713T supports full-step, half-step, 1/16-step, and 1/32-step resolution. These ICs are optimal for driving stepping motor of scanner and small printer.

Features

- Single-channel PWM constant-current control stepping motor driver incorporated.
- Microstepping is configurable to the following modes:
 - Full-step, half-step, quarter-step, or 1/8-step. (LV8712T)
 - Full-step, half-step, 1/16-step, or 1/32-step. (LV8713T)
- CLK-IN input facilitates the control of microstepping.
- Power-supply voltage of motor : VM max = 18V
- Output current $: I \cap max = 0.8A$
- : RON = 1.1 Ω (upper and lower total, typical, Ta = 25°C) Output ON resistance
- Thermal shutdown circuit and low voltage detecting circuit incorporated.

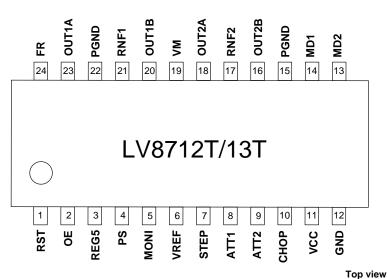
Typical Applications

- POS Printer
- Scanner
- Thermal Printer Unit
- Security camera
- Air-conditioner

Selection Guide

Part Number	Microstepping mode
LV8712T	Full-,half-,quarter-,1/8-step
LV8713T	Full-,half-,1/16-,1/32-step

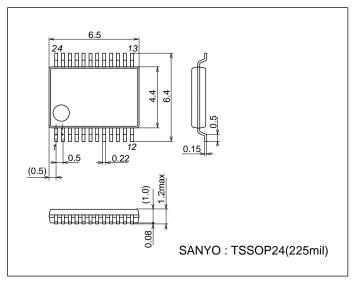
Pin Assignment



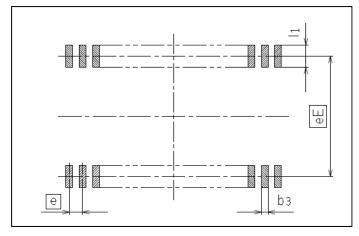
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Package Dimension

unit: mm (typ) 3260A



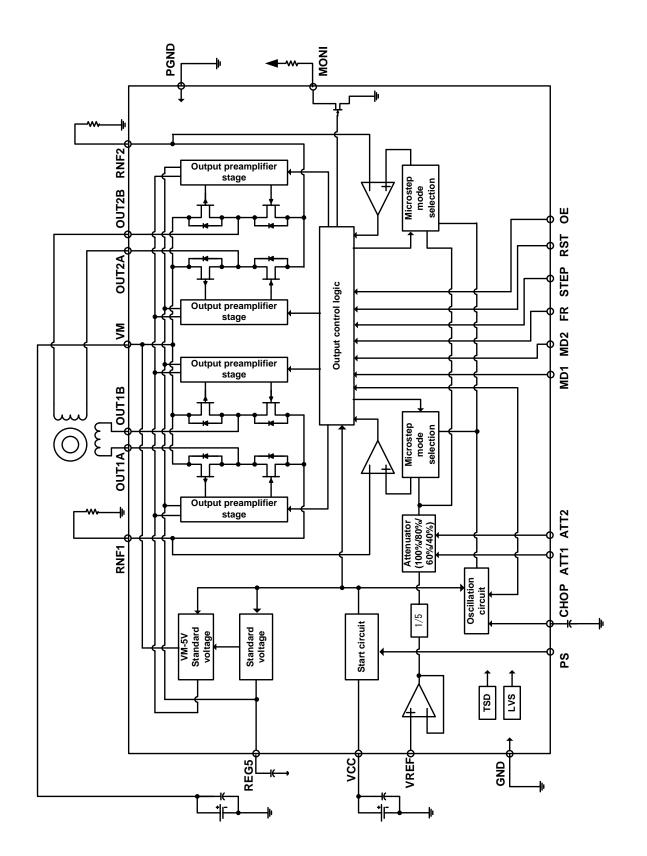
Mounting Pad Sketch



	(Unit:mm)
Reference symbol	TSSOP24 (225mil)
еE	5.80
е	0.50
b3	0.32
l1	1.00

Caution: The package dimension is a reference value, which is not a guaranteed value.

Block Diagram



Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Motor supply voltage	VM max		18	V
Logic supply voltage	V _{CC} max		6	V
Output peak current	I _O peak	Each 1ch, tw \leq 10ms, duty 20%	1.0	А
Output continuousness current	I _O max	Each 1ch	800	mA
Logic input voltage	VIN		-0.3 to V _{CC} + 0.3	V
Allowable power dissipation	Pd max	*	1.35	W
Operating temperature	Topr		-20 to +85	°C
Storage temperature	Tstg		-55 to +150	°C

* Specified circuit board: 57.0mm×57.0mm×1.7mm, glass epoxy 2-layer board.

Allowable Operating Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Motor supply voltage range	VM		4 to 16	V
Logic supply voltage range	VCC		2.7 to 5.5	V
Logic input voltage	VIN		-0.3 to V _{CC} +0.3	V
VREF input voltage range	VREF		0 to V _{CC} -1.8	V

Electrical Characteristics at Ta = 25°C, VM = 12V, VCC = 3.3V, VREF = 1.0V

Demonster	Ourseh al	Que distante		Ratings		Unit
Parameter	Symbol	Conditions	min	typ	max	Unit
Standby mode current drain	IMstn	PS = "L", no load			1	μΑ
	ICCstn	PS = "L", no load			1	μΑ
Operating mode current drain	IM	PS = "H", no load	0.3	0.5	0.7	mA
	ICC	PS = "H", no load	0.9	1.3	1.7	mA
Thermal shutdown temperature	TSD	Design guarantee		180		°C
Thermal hysteresis width	∆TSD	Design guarantee		40		°C
V_{CC} low voltage cutting voltage	VthV _{CC}		2.1	2.4	2.7	V
Low voltage hysteresis voltage	VthHIS		100	130	160	mV
REG5 output voltage	Vreg5	I _O = -1mA	4.5	5	5.5	V
Output on resistance	RonU	I _O = -800mA, Source-side on resistance		0.78	1.0	Ω
	RonD	I _O = 800mA, Sink-side on resistance		0.32	0.43	Ω
Output leakage current	lOleak	V _O = 15V			10	μA
Diode forward voltage	VD	ID = -800mA		1.0	1.2	V
Logic pin input current	IINL	V _{IN} = 0.8V	4	8	12	μΑ
	IINH	V _{IN} = 3.3V	22	33	45	μΑ
Logic high-level input voltage	VINH		2.0			V
Logic low-level input voltage	VINL				0.8	V
VREF input current	IREF	VREF = 1.0V	-0.5			μΑ
Current setting comparator	Vtatt00	ATT1 = L, ATT2 = L	0.191	0.200	0.209	V
threshold voltage	Vtatt01	ATT1 = H, ATT2 = L	0.152	0.160	0.168	V
(current attenuation rate switching)	Vtatt10	ATT1 = L, ATT2 = H	0.112	0.120	0.128	V
	Vtatt11	ATT1 = H, ATT2 = H	0.072	0.080	0.088	V
Chopping frequency	Fchop	Cchop = 220pF	36	45	54	kHz
CHOP pin threshold voltage	VCHOPH		0.6	0.7	0.8	V
	VCHOPL		0.17	0.2	0.23	V
CHOP pin charge/discharge current	lchop		7	10	13	μA
MONI pin saturation voltage	Vsatmon	lmoni = 1mA		250	400	mV

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LV8712T/LV8713T

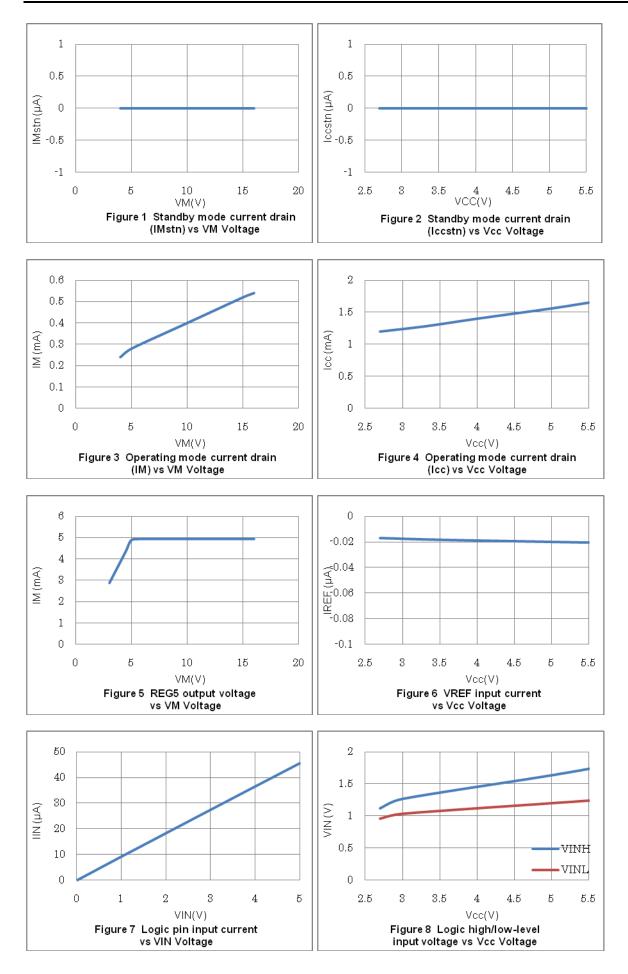
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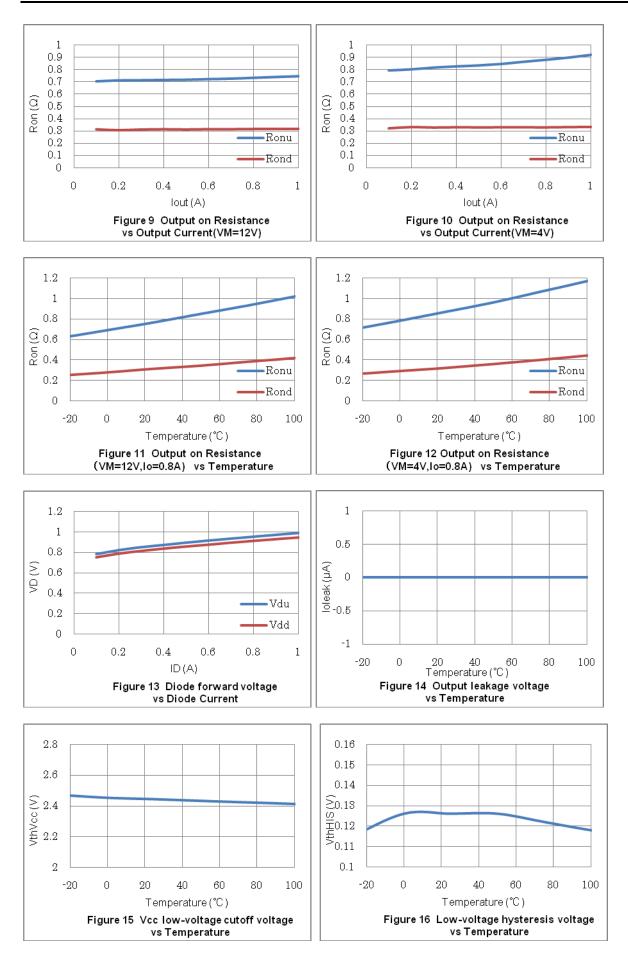
Para	meter	Symbol	Conditions	r	Ratings		Unit
		Cymbol		min	typ	max	
Current setting comparator	8W1-2-phase drive	Vtdac0_2W	Step 0 (When initialized: channel 1 comparator level)	0.191	0.200	0.209	V
threshold (1/32-step		Vtdac1_8W	Step 1 (Initial state+1)	0.191	0.200	0.209	V
voltage	at LV8713T)	Vtdac2_8W	Step 2 (Initial state+2)	0.191	0.200	0.209	V
(current step switching)		Vtdac3_8W	Step 3 (Initial state+3)	0.189	0.198	0.207	V
Switching)		Vtdac4_8W	Step 4 (Initial state+4)	0.187	0.196	0.205	V
		Vtdac5_8W	Step 5 (Initial state+5)	0.185	0.194	0.203	V
		Vtdac6_8W	Step 6 (Initial state+6)	0.183	0.192	0.201	V
		Vtdac7_8W	Step 7 (Initial state+7)	0.179	0.188	0.197	V
		Vtdac8_8W	Step 8 (Initial state+8)	0.175	0.184	0.193	V
		Vtdac9_8W	Step 9 (Initial state+9)	0.171	0.180	0.189	V
		Vtdac10_8W	Step 10 (Initial state+10)	0.167	0.176	0.185	V
		Vtdac11_8W	Step 11 (Initial state+11)	0.163	0.172	0.181	V
		Vtdac12_8W	Step 12 (Initial state+12)	0.158	0.166	0.174	V
		Vtdac13_8W	Step 13 (Initial state+13)	0.152	0.160	0.168	V
		Vtdac14_8W	Step 14 (Initial state+14)	0.146	0.154	0.162	V
		Vtdac15_8W	Step 15 (Initial state+15)	0.140	0.148	0.156	V
		 Vtdac16_8W	Step 16 (Initial state+16)	0.132	0.140	0.148	V
		Vtdac17 8W	Step 17 (Initial state+17)	0.126	0.134	0.142	V
		 Vtdac18_8W	Step 18 (Initial state+18)	0.118	0.126	0.134	V
		Vtdac19_8W	Step 19 (Initial state+19)	0.112	0.120	0.128	V
		Vtdac20_8W	Step 20 (Initial state+20)	0.102	0.110	0.118	V
		Vtdac21_8W	Step 21 (Initial state+21)	0.094	0.102	0.110	V
		Vtdac22_8W	Step 22 (Initial state+22)	0.086	0.094	0.102	v
		Vtdac22_6W Vtdac23_8W	Step 23 (Initial state+23)	0.000	0.086	0.094	V
		Vtdac26_6W	Step 24 (Initial state+24)	0.068	0.076	0.084	V
		Vtdac24_8W	Step 25 (Initial state+25)	0.060	0.078	0.076	V
		Vtdac25_8W	,				V
			Step 26 (Initial state+26)	0.050	0.058	0.066	V
		Vtdac27_8W	Step 27 (Initial state+27)	0.040	0.048	0.056	
		Vtdac28_8W	Step 28 (Initial state+28)	0.032	0.040	0.048	V
		Vtdac29_8W	Step 29 (Initial state+29)	0.022	0.030	0.038	V
		Vtdac30_8W	Step 30 (Initial state+30)	0.012	0.020	0.028	V
		Vtdac31_8W	Step 31 (Initial state+31)	0.002	0.010	0.018	V
	4W1-2-phase drive	Vtdac0_4W	Step 0 (When initialized: channel 1 comparator level)	0.191	0.200	0.209	V
	(1/16-step	Vtdac2_4W	Step 2 (Initial state+1)	0.191	0.200	0.209	V
	at LV8713T)	Vtdac4_4W	Step 4 (Initial state+2)	0.187	0.196	0.205	V
		Vtdac6_4W	Step 6 (Initial state+3)	0.183	0.192	0.201	V
		Vtdac8_4W	Step 8 (Initial state+4)	0.175	0.184	0.193	V
		Vtdac10_4W	Step 10 (Initial state+5)	0.167	0.176	0.185	V
		Vtdac12_4W	Step 12 (Initial state+6)	0.158	0.166	0.174	V
		Vtdac14_4W	Step 14 (Initial state+7)	0.146	0.154	0.162	V
		Vtdac16_4W	Step 16 (Initial state+8)	0.132	0.140	0.148	V
		Vtdac18_4W	Step 18 (Initial state+9)	0.118	0.126	0.134	V
		Vtdac20_4W	Step 20 (Initial state+10)	0.102	0.110	0.118	V
		Vtdac22_4W	Step 22 (Initial state+11)	0.086	0.094	0.102	V
		Vtdac24_4W	Step 24 (Initial state+12)	0.068	0.076	0.084	V
		Vtdac26_4W	Step 26 (Initial state+13)	0.050	0.058	0.066	V
		Vtdac28_4W	Step 28 (Initial state+14)	0.032	0.040	0.048	V
		Vtdac30_4W	Step 30 (Initial state+15)	0.012	0.020	0.028	V

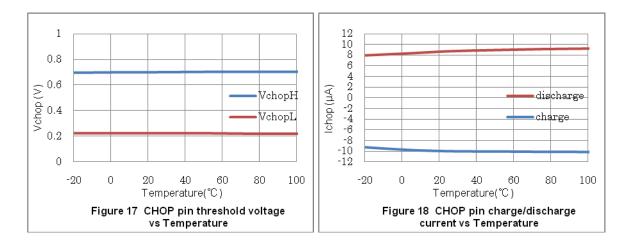
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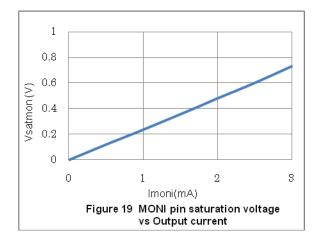
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Parameter		Querra ha a l	O and difference		Ratings		1.1 14
		Symbol Conditions		min	typ	max	Unit
Current setting comparator	2W1-2-phase drive (1/8-step	Vtdac0_2W	Step 0 (When initialized: channel 1 comparator level)	0.191	0.2	0.209	V
threshold	at LV8712T)	Vtdac4_2W	Step 4 (Initial state+1)	0.187	0.196	0.205	V
voltage		Vtdac8_2W	Step 8 (Initial state+2)	0.175	0.184	0.193	V
(current step switching)		Vtdac12_2W	Step 12 (Initial state+3)	0.158	0.166	0.174	V
switching)		Vtdac16_2W	Step 16 (Initial state+4)	0.132	0.140	0.148	V
		Vtdac20_2W	Step 20 (Initial state+5)	0.102	0.110	0.118	V
		Vtdac24_2W	Step 24 (Initial state+6)	0.068	0.076	0.084	V
		Vtdac28_2W	Step 28 (Initial state+7)	0.032	0.040	0.048	V
	W1-2-phase drive (quarter-step at LV8712T) 1-2 phase drive (half-step at	Vtdac0_W	Step 0 (When initialized: channel 1 comparator level)	0.191	0.200	0.209	V
		Vtdac8_W	Step 8 (Initial state+1)	0.175	0.184	0.193	V
		Vtdac16_W	Step 16 (Initial state+2)	0.132	0.140	0.148	V
		Vtdac24_W	Step 24 (Initial state+3)	0.068	0.076	0.084	V
		Vtdac0_H	Step 0 (When initialized: channel 1 comparator level)	0.191	0.200	0.209	V
	LV8712T/13T)	Vtdac16_H	Step 16 (Initial state+1)	0.132	0.140	0.148	V
	2 phase drive (full-step at LV8712T/13T)	Vtdac16_F	Step 16' (When initialized: channel 1 comparator level)	0.191	0.200	0.209	V









LV8712T/LV8713T

Pin F	unctions	5	
Pin No.	Pin Name	Pin Function	Equivalent Circuit
1 2	RST OE	Excitation reset signal input pin. Output enable signal input pin.	Vcc o
7	STEP	STEP signal input pin.	
8	ATT1	Motor holding current switching pin.	
9	ATT2	Motor holding current switching pin.	
13	MD2	Excitation mode switching pin 2.	6κΩ + Ε
14	MD1	Excitation mode switching pin 1.	
24	FR	CW / CCW switching signal input pin.	GND ο
4	PS	Power save signal input pin.	
16	OUT2B	Channel 2 OUTB output pin.	VM
17	RNF2	Channel 2 current-sense resistor	
10	OUT24	connection pin.	
18	OUT2A	Channel 2 OUTA output pin.	
20 21	OUT1B RNF1	Channel 1 OUTB output pin. Channel 1 current-sense resistor connection pin.	
23	OUT1A	Channel 1 OUTA output pin	$GND \circ \qquad $
6	VREF	Constant current control reference voltage input pin.	

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LV8712T/LV8713T

	ed from preced	ling page.	
Pin No.	Pin Name	Pin Function	Equivalent Circuit
3	REG5	Internal power supply capacitor connection pin.	V _M
5	MONI	Position detection monitor pin.	Vcc
			5 ξ 100Ω
10	СНОР	Chopping frequency setting capacitor connection pin.	

Operation description

Stepping motor control

1. Power save function

This IC is switched between standby and operating mode by setting the PS pin. In standby mode, the IC is set to power-save mode and all logic is reset. In addition, the internal regulator circuit does not operate in standby mode.

PS	Mode	Internal regulator
Low or Open	Standby mode	Standby
High	Operating mode	Operating

2. The recommended order of power supply

It is recommendable that the power supplies are turned on in the following order.

VCC power supply \rightarrow VM power supply \rightarrow PS pin = High

For turning off the power supplies, the order should be reversed.

However, the above-mentioned order is presented only as a recommendation, and noncompliance is not going to be the cause of over-current or IC destruction.

3. STEP pin function

I	nput	Operating mode
PS	STP	
Low	*	Standby mode
High		Excitation step proceeds
High		Excitation step is kept

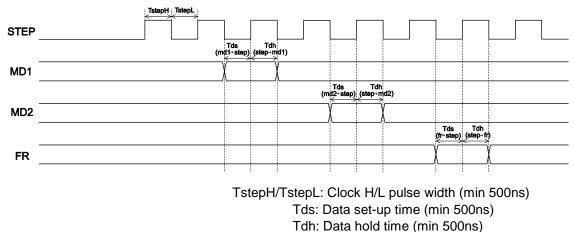
STEP input advances electrical angle at every rising edge (advances step by step).

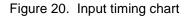
STEP input MIN pulse width (common in H/L): 500ns (MAX input frequency: 1MHz)

However, constant current control is performed by PWM during chopping period, which is set by the capacitor connected between CHOP and GND. You need to perform chopping more than once per step. For this reason, for the actual STEP frequency, you need to take chopping frequency and chopping count into consideration.

For example, if chopping frequency is $50kHz (20\mu s)$ and chopping is performed twice per step, the maximum STEP frequency is obtained as follows: $f=1/(20\mu sx2) = 25kHz$.

4. Input timing





5. Microstepping mode setting function (initial position)

<LV8712T>

MD1	MD2	Microstepping	Excitation mode	Initial position	
		Resolution		Channel 1	Channel 2
Low	Low	Full Step	2 Phase	100%	-100%
High	Low	Half Step	1-2 Phase	100%	0%
Low	High	Quarter Step	W1-2 Phase	100%	0%
High	High	1/8 Step	2W1-2 Phase	100%	0%

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MD1	MD2	Microstepping	Excitation mode	Initial position		
		Resolution		Channel 1	Channel 2	
Low	Low	Full Step	2 Phase	100%	-100%	
High	Low	Half Step	1-2 Phase	100%	0%	
Low	High	1/16 Step	4W1-2 Phase	100%	0%	
High	High	1/32 Step	8W1-2 Phase	100%	0%	

This is the initial position of each excitation mode in the initial state after power-on and when the counter is reset.

6. Initial Position monitoring function

MONI pin monitors the initial position which is open drain. When the excitation is in the initial position, the MONI output is turned on. (Refer to " (13) Examples of current waveforms in the respective excitation modes.")

7. Reset function

RST	Operating mode
High	Normal operation
Low	Reset state

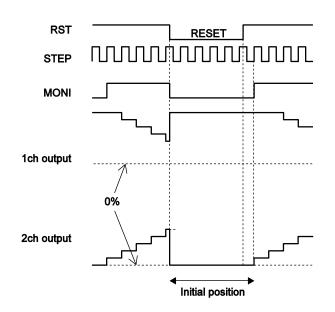


Figure 21. Reset function timing chart

When the RST pin is Low, the excitation position of the output is forcibly set to the initial position, and the MONI output is turned on. When RST turns High, the excitation position is advanced by the next STEP input.

8. Output enable function

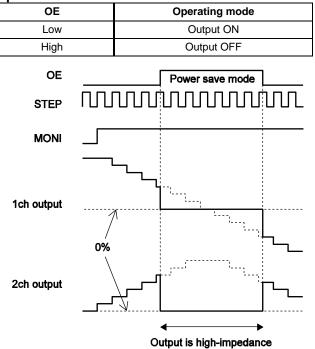


Figure 22. Output enable function timing chart

When the OE pin is High, the output turns OFF by force and turns to high impedance. However, since the internal logic circuits are under operation, the excitation position proceeds when the STEP signal is input. Therefore, when OE turns Low again, the output level follows the excitation position led by the STEP input.

9. Forward/reverse switching function

	0
FR	Operating mode
Low	Clockwise (CW)
High	Counter-clockwise (CCW)

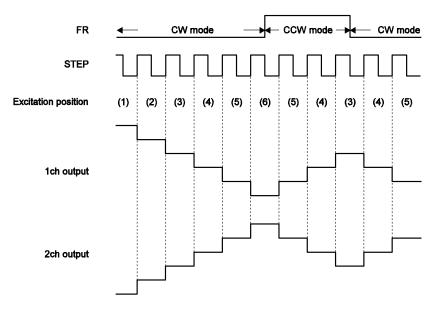


Figure 23. Forward/Reverse switching function timing chart

The internal D/A converter proceeds by one bit at the rising edge of the input STEP pulse. In addition, CW and CCW mode are switched by setting the FR pin. In CW mode, the channel 2 current phase is delayed by 90° relative to the channel 1 current.

In CCW mode, the channel 2 current phase is advanced by 90° relative to the channel 1 current.

10. Constant current control setting

The setting of STM driver's constant current control is determined by the following based on the VREF voltage and the resistor connected between RNF and GND.

IOUT = (VREF/5) /RNF resistance

* The above formula gives setting value where the output current is100% in each excitation mode.

If VREF is open or the setting is out of the recommendation operating range, output current will increase and you cannot set constant current under normal condition. Hence, make sure that VREF is set in accordance with the specification.

However, if current control is not performed (if the IC is used by saturation drive or used without current limit at DCM) make sure that the setting is as follows: VREF=5V or VREF=VREG5

Power dissipation of RF resistor is obtained as follows: Pd=Iout²×RF. Make sure to take allowable power dissipation into consideration when you select RF resistor.

The voltage input to the VREF pin can be switched to four-step settings depending on the statuses of the two inputs, ATT1 and ATT2. This is effective for reducing power consumption when motor holding current is supplied.

ATT1	ATT2	Current setting reference voltage attenuation ratio
Low	Low	100%
High	Low	80%
Low	High	60%
High	High	40%

Attenuation function for VREF input voltage

The formula is given below which is used to calculate the output current when using the function for attenuating the VREF input voltage.

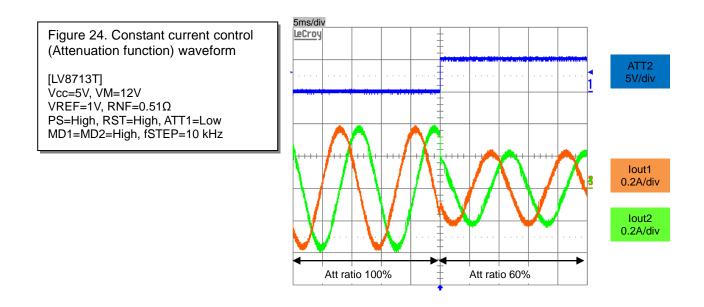
IOUT = (VREF/5) × (attenuation ratio) /RNF resistance

Example: At VREF of 1.0V and a reference voltage setting is 100% [(ATT1, ATT2) = (L, L)] and an RNF resistance of 0.5Ω , the output current is set as follows.

 $I_{OUT} = 1.0V/5 \times 100\%/0.5\Omega = 400$ mA

If (ATT1, ATT2) is set to (H, H) in this state, IOUT is obtained as follows: IOUT = 400mA × 40% = 160mA

In this way, the output current is attenuated when the motor holding current is supplied for power saving.



11. Chopping frequency setting

For constant-current control, this IC performs chopping operations at the frequency determined by the capacitor (Cchop) connected between the CHOP pin and GND. The chopping frequency is set as shown below by the capacitor (Cchop) connected between the CHOP pin and GND.

Tchop ≈Cchop × Vtchop × 2 / Ichop (s) Vtchop: Width of threshold voltage (VchopH-VchopL), typ 0.5V Ichop: Charge/discharge current, typ 10μA

Fchop ≈1 / Tchop (Hz)

For instance, when Cchop is 220pF, the chopping frequency will be as follows: Fchop =1/Tchop= 10 μ A/ (220pF × 0.5V × 2) = 45 kHz

The higher the chopping frequency is, the greater the output switching loss becomes. As a result, heat generation issue arises. The lower the chopping frequency is, the lesser the heat generation becomes. However, current ripple occurs. Since noise increases when switching of chopping takes place, you need to adjust frequency with the influence to the other devices into consideration. The frequency range should be between 40 kHz and 125 kHz.

12. Output current vector locus (one step is normalized to 90 degrees)

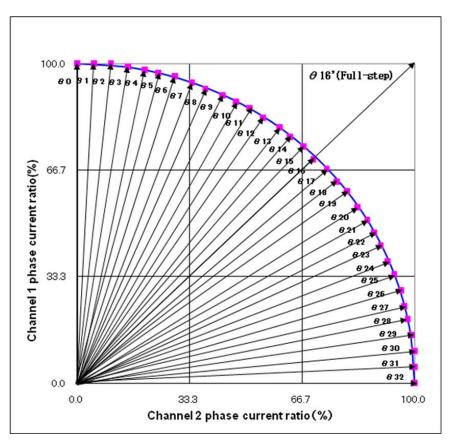


Figure 25.Output current vector

STEP	current r		selectable	0100100	-		electable		LV87	12T/LV87	13T select	able
	1/32		1/16 Step		1/8 S		Quarter	r Step	Half S	Step	Full	Step
	Ch- 1	Ch- 2	Ch- 1	Ch- 2	Ch- 1	Ch- 2	Ch- 1	Ch- 2	Ch- 1	Ch- 2	Ch- 1	Ch- 2
	(%)	(%)	(%)	(%)	(%)	(%)	(%)	(%)	(%)	(%)	(%)	(%)
θ0	100	0	100	0	100	0	100	0	100	0		
θ1	100	5										
θ2	100	10	100	10								
θ3	99	15										
θ4	98	20	98	20	98	20						
θ5	97	24										
06	96	29	96	29								
θ7	94	34										
8 0	92	38	92	38	92	38	92	38				
θ9	90	43										
θ10	88	47	88	47								
θ11	86	51										
θ12	83	55	83	55	83	55						
θ13	80	60										
θ14	77	63	77	63								
θ 15	74	67										
θ 16	70	70	70	70	70	70	70	70	70	70	100	100
θ17	67	74										
θ 18	63	77	63	77								
θ 19	60	80										
θ20	55	83	55	83	55	83						
θ 21	51	86										
θ 22	47	88	47	88								
θ 23	43	90										
024	38	92	38	92	38	92	38	92				
θ 25	34	94										
θ 26	29	96	29	96								
θ27	24	97										
θ28	20	98	20	98	20	98						
θ29	15	99										
θ30	10	100	10	100								
0 31	5	100										
θ 32	0	100	0	100	0	100	0	100	0	100		

Setting current ration in each Microstepping mode

13. Typical current waveform in each excitation mode

Figure 26. Full-Step resolution (FR="Low")

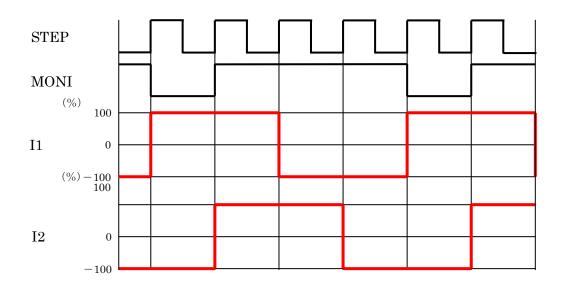
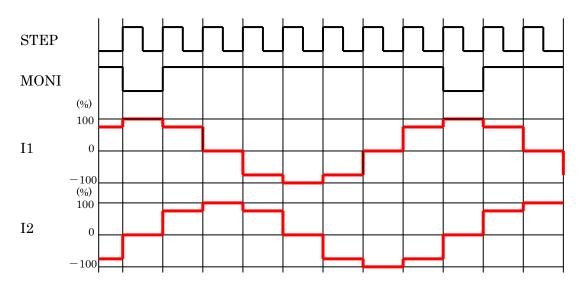
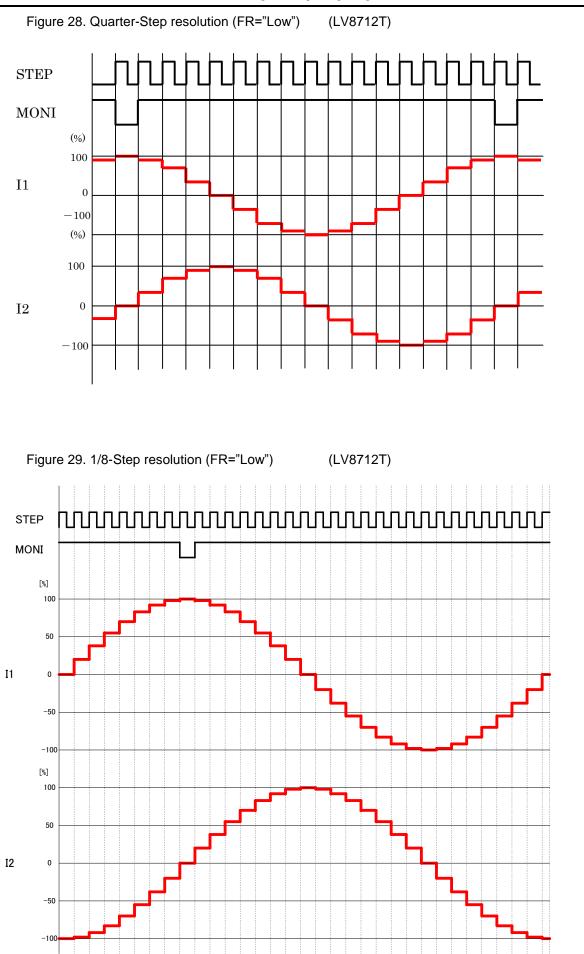
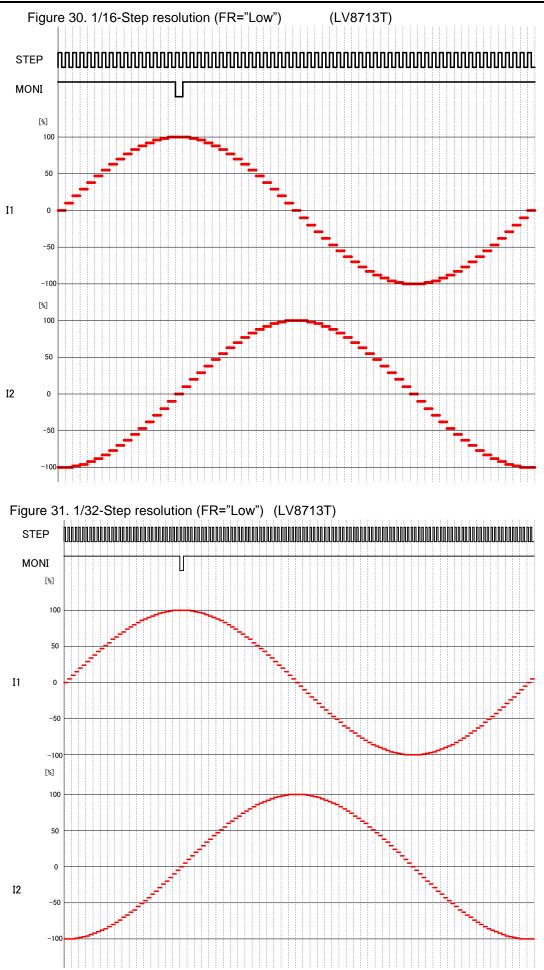


Figure 27. Half-Step resolution (FR="Low")







LV8712T/LV8713T

14. Constant Current control (Chopping operation)

(Sine wave increasing direction)

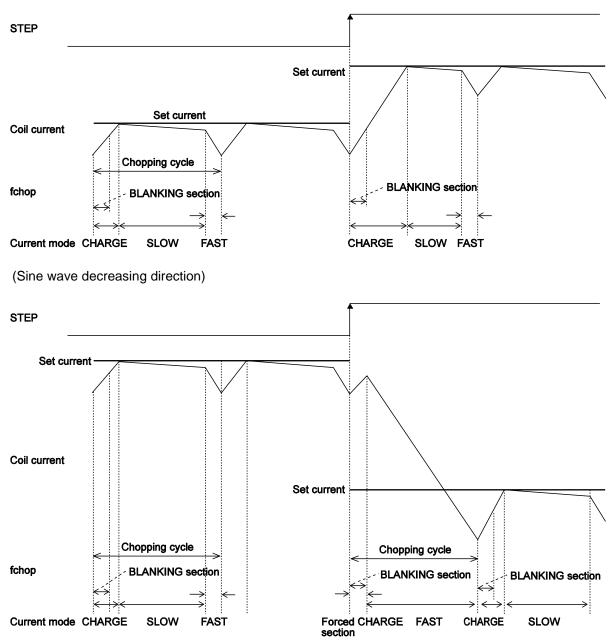


Figure 32. Constant current control timing chart

In each current mode, the operation sequence is as described below:

- At rise of chopping frequency, the CHARGE mode begins. (The Blanking section in which the CHARGE mode is forced regardless of the magnitude of the coil current (ICOIL) and set current (IREF) exists for 1µs.)
- The coil current (ICOIL) and set current (IREF) are compared in this blanking time.

When (ICOIL < IREF) state exists;

The CHARGE mode up to ICOIL \geq IREF, then followed by changeover to the SLOW DECAY mode, and finally by the FAST DECAY mode for approximately 1 μ s.

When (ICOIL < IREF) state does not exist;

The FAST DECAY mode begins. The coil current is attenuated in the FAST DECAY mode till one cycle of chopping is over.

Above operations are repeated. Normally, the SLOW (+FAST) DECAY mode continues in the sine wave increasing direction, then entering the FAST DECAY mode till the current is attenuated to the set level and followed by the SLOW DECAY mode.

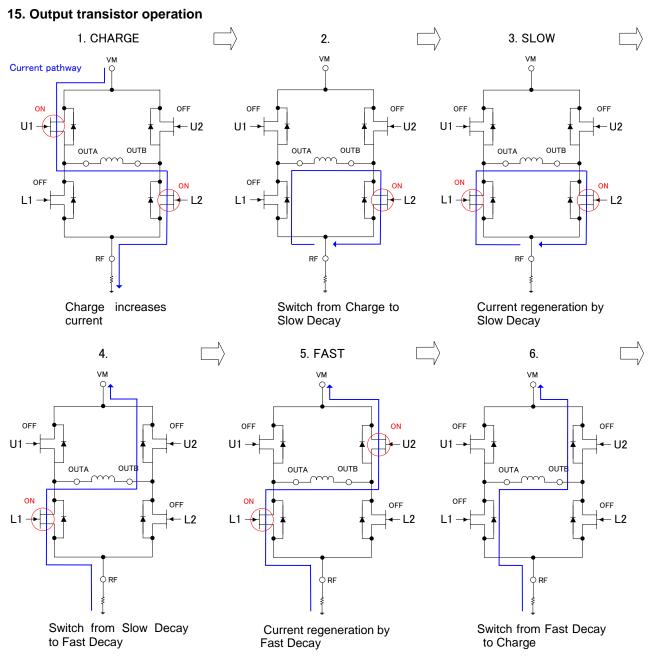


Figure 33 . Output transistor operation sequence

This IC controls constant current by performing chopping to output transistor.

As shown above, by repeating the process from 1 to 6, setting current is maintained.

Chopping consists of 3 modes: Charge/ Slow decay/ Fast decay. In this IC, for switching mode (No.2, 4, 6), there are "off period" in upper and lower transistor to prevent crossover current between the transistors. This off period is set to be constant ($\approx 0.375\mu$ s) which is controlled by the internal logic. The diagrams show parasitic diode generated due to structure of MOS transistor. When the transistor is off, output current is regenerated through this parasitic diode.

Output FET control function

	Output Tr	CHARGE	SLOW	FAST
	Ú1	ON	OFF	OFF
	U2	OFF	OFF	ON
	L1	OFF	ON	ON
	L2	ON	ON	OFF
OU	TB→OUTA (CHARG	E)		
	Output Tr	CHARGE	SLOW	FAST
	U1	OFF	OFF	ON
	U2	ON	OFF	OFF
	L1	ON	ON	OFF
	L2	OFF	ON	ON

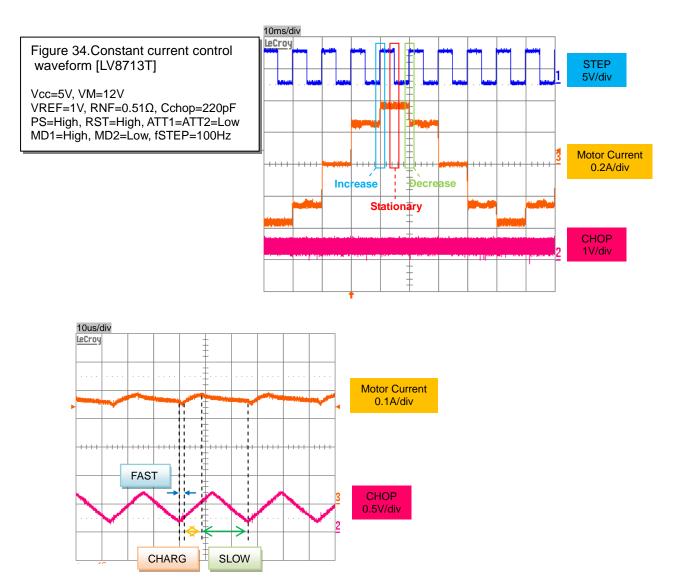


Figure 35. Constant current control waveform (Stationary state)

Motor current switches to Fast Decay mode when triangle wave (CHOP) switches from Discharge to Charge. Approximately after 1µs, the motor current switches to Charge mode. When the current reaches to the setting current, it is switched to Slow Decay mode which continues over the Discharge period of triangle wave.

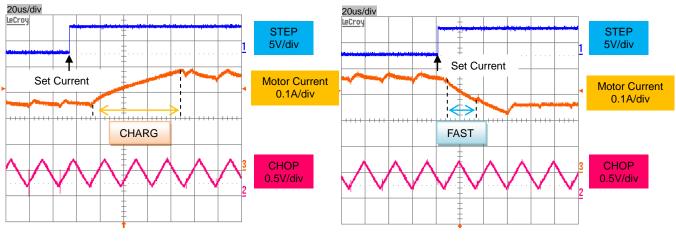
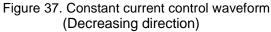


Figure 36. Constant current control waveform (Increasing direction)

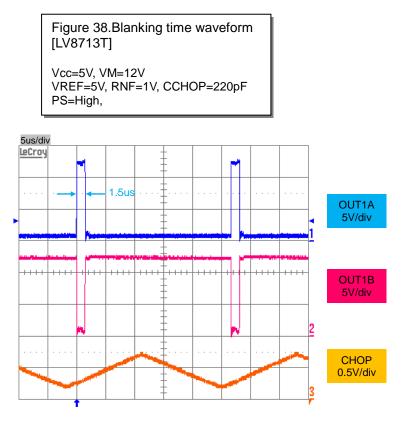


16. Blanking time

If, when exercising PWM constant-current chopping control over the motor current, the mode is switched from decay to charge, the recovery current of the parasitic diode may flow to the current sensing resistance, causing noise to be carried on the current sensing resistance pin, and this may result in false over current detection. To prevent this false detection, a blanking time is provided to prevent the noise occurring during mode switching from being received. During this time, the mode is not switched from charge to decay even if noise is carried on the current sensing resistance pin.

The blanking time, tBLANK (µs), is approximately

tBLANK≈1µs



From the above Fig. , the blanking time appears to be 1.5 μ s. However, since the mode shifts from charge (blanking time), OFF, to DECAY, the actual blanking time is obtained as follows: Blanking time=1 μ s + OFF zone = 0.5 μ s

17. Microstepping mode switching operation

When Microstepping mode is switched while the motor is rotating, each drive mode operates with the following sequence.

Microstepping mode	Step angle	1/32 Step	1/16 Step	1/8 Step	Quarter Step	Half Step	Full Step
	00.04			1/0 0100	Quarter Otep		Full Step
	00-01	/	θ2	θ4	θ8	θ 16	θ16'
	02-03	/	θ4	04	θ8	θ 16	θ 16 '
	0 4- 0 5	/	θ 6	8 0	08	θ 16	θ 16 '
	06-07	/	θ8	8 0	θ 8	θ16	θ 16 '
	08-09	/	θ10	θ 12	θ16	θ 16	θ 16 '
	010-011		θ12	θ 12	θ16	θ16	θ 16 '
	012-013	/	θ14	θ 16	θ16	θ 16	θ 16 '
4/00 01	014-015		θ 16	θ 16	θ16	θ 16	θ 16 '
1/32 Step Resolution	θ 16- θ17	/	θ 18	θ20	θ24	θ 32	θ 16 '
Resolution	018-019		θ20	θ20	θ24	θ 32	θ 16 '
	θ 20- θ21		θ22	θ24	θ24	θ 32	θ 16 '
	022-023		024	θ24	θ24	0 32	θ 16 '
	024-025		θ 26	θ28	θ32	032	θ 16 '
	026-027		028	θ28	θ32	θ 32	θ16'
	028-029		θ 30	θ32	θ32	032	θ 16 '
	030-031	/	032	θ32	θ32	θ 32	θ 16 '
	θ 32	/	-030	-028	-024	-016	-016'
	00	θ1	/	θ4	8 0	θ 16	θ 16 '
	θ2	θ3	/	04	θ8	θ 16	θ16'
	04	θ5	/	08	θ 8	θ 16	θ 16 '
	06	θ7	/	08	θ 8	θ 16	θ 16 '
	08	09		012	θ16	θ 16	θ16'
	θ 10	θ11		θ12	θ16	θ 16	θ16'
	θ12	013 015 017 019 021		016	θ16	θ16	θ 16 '
	014			016	θ16	θ 16	θ16'
1/16 Step	θ16			θ20	θ24	032	θ16'
Resolution	θ18			θ20	θ24	032	θ16'
	θ20			θ24	θ24	032	θ16'
	θ22	θ23		θ24	θ24	032	θ16'
	θ24	025		028	032	θ32	θ16'
	026	θ27		028	θ32	032	θ16'
	θ28	θ29		032	032	032	θ 16 '
	030	θ31		032	032	032	θ 16 '
	032	-031	/	-028	-024	-016	-016'
	θ0	θ1	θ2		08	016	θ16'
	θ4	θ5	θ6	1 /	08	016	θ16'
	08	θ 9	θ10	1 /	θ 16	θ16	θ 16 '
	θ12	θ13	θ14	1 /	θ16	θ 16	θ 16 '
1/8 Step	016	θ17	θ18	1 /	θ24	032	θ16'
Resolution	θ20	θ21	θ22		θ24	032	θ16'
	024	θ25	026		032	032	θ16'
	θ28	θ29	θ30		032	032	θ16'
	032	-031	- 0 30	1/	-024	- 0 16	-016'
	θ0	θ1	θ2	θ4	/	θ16	θ16'
	00	θ 9	θ10	θ12	1 /	θ16	θ16 [']
Quarter Step	θ 16	θ17	θ18	θ20	1 /	θ 32	θ16 [']
Resolution	θ 24	θ25	θ26	θ28	1 /	θ32	θ16 [']
	θ24 θ32	-023	- 0 30	-028	1/	-016	-016'
	θ0	θ1	-θ30 θ2	-020 04	08	/	θ16 [']
Half Step	θ0 θ16	θ17	θ2 θ18	θ4 θ20	θ8		θ16 [']
Resolution	θ16 θ32	-031	-030	-θ20 -θ28	-θ24 -θ24		-016'
Full Step	θ32 θ16'	θ17	-θ30 θ18	-028 020	-024 024	θ32	-010

*As for $\theta 0$ to $\theta 32,$ please refer to the step position of current ratio setting.

If you switch Microstepping mode while the motor is driving, the mode setting will be reflected from the next STEP and the motor advances to the position shown in the following.

(a) Microstepping $(1/32, 1/16, 1/8, \text{Quarter-Half-step}) \rightarrow \text{Microstepping} (1/32, 1/16, 1/8, \text{Quarter-Half-step})$

When a microstepping switches to the next microstepping, the excitation position is switched to the next corresponding step angle of the next microstepping mode.

e.g.) When the rotation direction is forward at 1/16-step ($\theta 6$) and if you switch to 1/8 step, the step angle is set to $\theta 8$ at the next step.

When the rotation direction is forward at 1/16-step ($\theta 20$) and if you switch to 1/8 step, the step angle is set to θ 24 at the next step.

(b) Microstepping $(1/32, 1/16, 1/8, Quarter, Half-step) \rightarrow Full-step$

When a microstepping switches to the full-step, the excitation position is switched to full-step angle of the present quadrant. Caution is required when switching from $\theta 16$ or higher step angle of microstepping position to full-step.

e.g.) When the rotation direction is forward at 1/8 step ($\theta 8$) and if you switch to full-step, the step angle is set to 016' at the next step.

When the rotation direction is forward at 1/8 step ($\theta 16$) and if you switch to full-step, the step angle is set to θ 16' at the next step. (the electric angle is the same but the absolute value changes)

When the rotation direction is forward at 1/8 step (θ 24) (the electric angle returns and the absolute value changes)

(c) Full-step \rightarrow Microstepping (1/32-,1/16-,1/8-,Quarter-.Half-step)

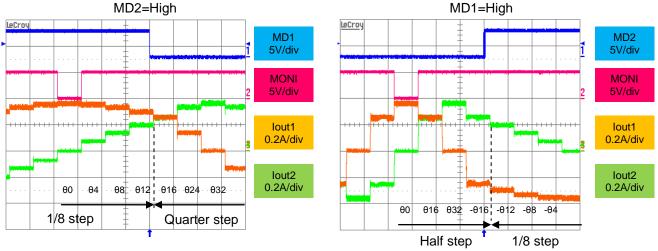
When full step switches to microstepping, the excitation position is switched to the next corresponding step angle.

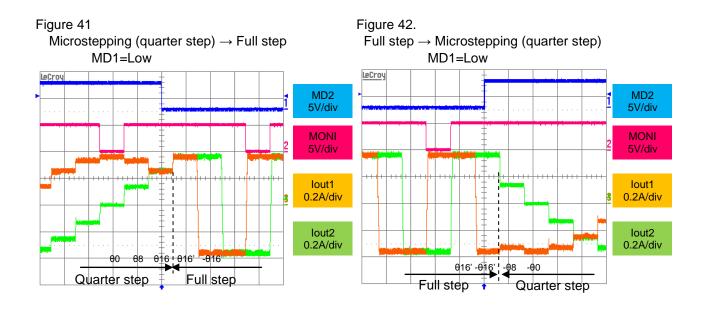
e.g.) When the rotation direction is forward at Full step (θ 16') and if you switch to 1/8 step, the step angle is set to $\theta 20$ at the next step.

Microstep mode switching operation [LV8712T] Vcc=5V, VM=12V VREF=1V,RNF=0.51 Ω PS=High, RST=High, fSTEP=100Hz

Figure 39

Figure 40. Microstepping (1/8step) \rightarrow Microstepping (quarter step) Microstepping (Half-step) \rightarrow Microstepping (1/8 step)



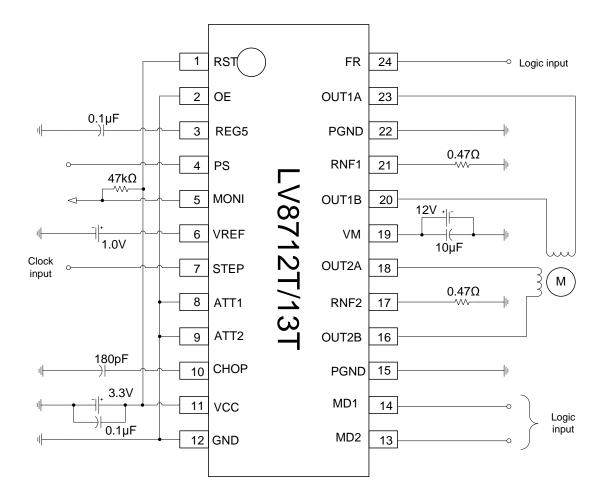


Thermal shutdown function

The thermal shutdown circuit is incorporated and the output is turned off when junction temperature Tj exceeds 180°C. As the temperature falls by hysteresis, the output turned on again (automatic restoration). The thermal shutdown circuit does not guarantee the protection of the final product because it operates when the temperature exceed the junction temperature of Tjmax=150°C.

 $TSD = 180^{\circ}C (typ)$ $\Delta TSD = 40^{\circ}C (typ)$

Application Circuit Example



The formulae for setting the constants in the examples of the application circuits above are as follows: Constant current (100%) setting

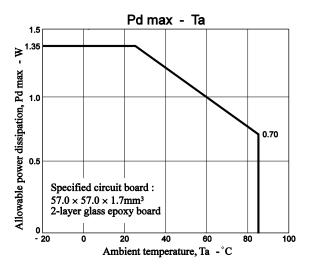
When VREF = 1.0V

$$\begin{split} I_{OUT} &= VREF/5/RNF \ resistance \\ &= 1.0V/5/0.47\Omega = 0.426A \\ Chopping \ frequency \ setting \\ Fchop &= Ichop/ \ (Cchop \times Vtchop \times 2) \\ &= 10 \mu A/ \ (180 pF \times 0.5V \times 2) = 55 \ kHz \end{split}$$

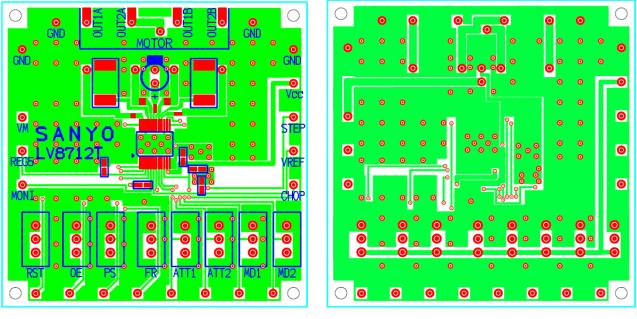
Allowable power dissipation

Evaluation board

Size: 57mm x 57mm x 1.7mm, glass epoxy 2-layer board



Evaluation board Design Diagram



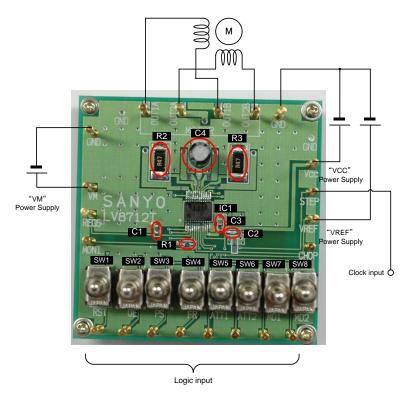
TOP View

Evaluation board

1. Completed PCB with Devices

The evaluation board of LV8712T and LV8713T is common.

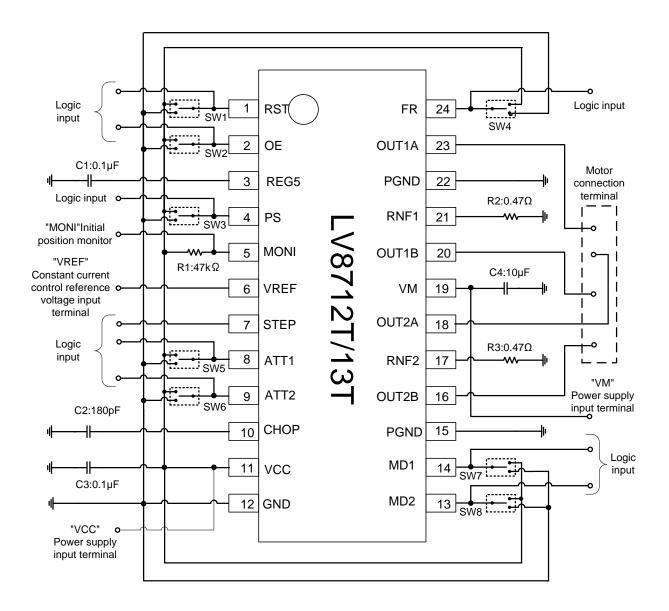
PCB size: 57mm×57mm×1.7mm, glass epoxy 2-layer board



2.Bill of Materials for LV8712T/13T Evaluation Board

Designator	Quantity	Description	Value	Tolerance	Footprint	Manufacturer	Manufacturer Part Number	Substitution Allowed	Lead Free
Designator	Quantity		Value	Tolerance	rootprint	Manufacturer	Number	Allowed	1100
		REG5							
04	4	stabilization	0.1µF,	. 4.00/		Munata		¥	
C1	1	Capacitor	100V	±10%		Murata	GRM188R72A104KA35*	Yes	Yes
		Capacitor to							
		set	100-5						
C2	4	chopping	180pF,	. 50/		Munata	GRM1882C1H181JA01*	¥	
62	1	frequency	50V	±5%		Murata	GRM1882C1H181JA01*	Yes	Yes
			0.4.5						
00		VCC Bypass	0.1µF,	100/				N/	~
C3	1	Capacitor	100V	±10%		Murata	GRM188R72A104KA35*	Yes	Yes
<u></u>		VM Bypass	10µF,	000/		SUN Electronic	FOL ME LOU LO	N	~
C4	1	Capacitor	50V	±20%		Industries	50ME10HC	Yes	Yes
		Pull-up							
		Resistor for	47kΩ,						
R1	1	for pin MONI	1/10W	±5%		KOA	RK73B1JT**473J	Yes	Yes
		Channel 1							
		output current							
		detective	0.47Ω,						
R2	1	Resistor	1W	±5%		ROHM	MCR100JZHJLR47	Yes	Yes
		Channel 2							
		output current	0.470						
50		detective	0.47Ω,	50/		DOUM		N	~
R3	1	Resistor	1W	±5%		ROHM	MCR100JZHJLR47	Yes	Yes
					TSSOP24	SANYO	LV8712T		
IC1	1	Motor Driver			(225mil)	semiconductor	LV8713T	No	Yes
	0	Curitob				MIYAMA	ME 6010 A01	Vee	Vac
SW1-SW8	8	Switch				ELECTRIC	MS-621C-A01	Yes	Yes
TP1-TP21	21	Test Point				MAC8	ST-1-3	Yes	Yes

3. Evaluation board circuit



4.Evaluation Board Manual

[Supply Voltage]	VM (4 to 16V): Motor Power Supply
	VCC (2.7 to 5.5V): Control Power Supply
	VREF (0 to VCC-1.8V): Const. Current Control for Reference Voltage

[Toggle Switch State] Upper Side: High (VCC) Middle: Open, enable to external logic input Lower Side: Low (GND)

[Operation Guide]

- 1. Initial Condition Setting: Set "Open or Low" all switches
- 2. Motor Connection: Connect the Motors between OUT1A and OUT1B, between OUT2A and OUT2B.
- 3. Power Supply: Supply DC voltage to VCC, VM and VREF.
- 4. **Ready for Operation from Standby State:** Turn "High" the PS pin toggle switch. Channel 1 and 2 are into full-step excitement initial position (100%, -100%).
- 5. <u>Motor Operation:</u> Turn "High" the RST pin toggle switch. Input the clock signal into the pin STEP.
- 6. Other Setting (See Application Note for detail)
 - i. ATT1, ATT2: Motor current attenuation.
 - ii. FR: Motor rotation direction (CW / CCW) setting.
 - iii. MD1, MD2: Microstepping Resolution.
 - iv. OE: Output Enable.

[Setting for External Component Value]

1. Constant Current (100%)

At VREF=1.0V lout =VREF [V] / 5 / RNF [ohm] =1.0 [V] / 5 / 0.47 [ohm] =0.426 [A]

2. Chopping Frequency

Fchop =Ichop [uA] / (Cchop x Vt x 2) =10 [uA] / (180 [pF] x 0.5 [V] x 2) =55 [kHz]

5. Evaluation Board waveform (Stepping motor drive)

LV8712T VM=12V, VCC=5V,VREF=1.0V PS=High,RST=High ATT1=ATT2=FR=OE=Low

Figure 43.

Full-step (MD1=MD2=Low, fSTEP=500Hz)



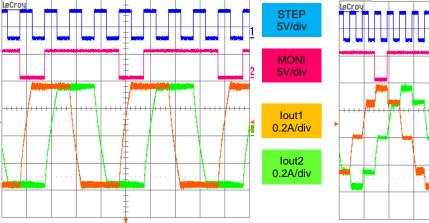


Figure 44. Half-step (MD1=High, MD2=Low, fSTEP=1 kHz)

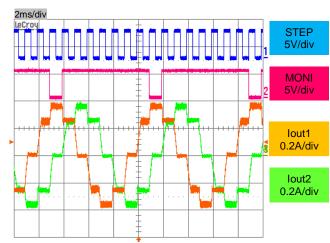
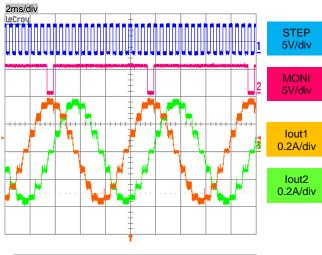


Figure 45.

Quarter-step (MD1=Low,MD2=High, fSTEP=2kHz)



LV8713T VM=12V, VCC=5V, VREF=1.0V PS=High, RST=High ATT1=ATT2=FR=OE=Low

Figure 47.

Full-step (MD1=MD2=Low, fSTEP=500Hz)

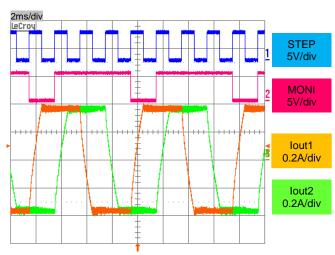


Figure 49.

1/16-step (MD1=Low,MD2=High, fSTEP=8kHz)

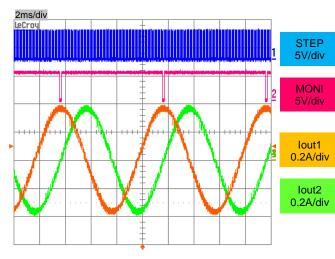


Figure 46.

1/8-step (MD1=MD2=High, fSTEP=4kHz)

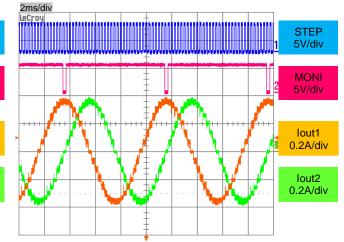


Figure 48 Half-step (MD1=High, MD2=Low, fSTEP=1 kHz)

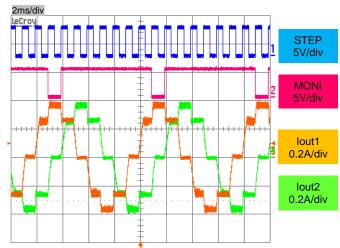
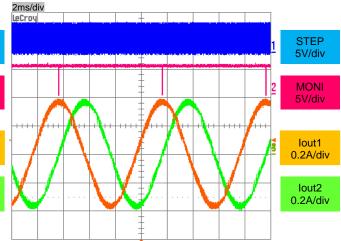


Figure 50.

1/32-step (MD1=MD2=High, fSTEP=16kHz)



Cautions for layout:

•Power supply connection pin [VM]

- \checkmark VCC is a control power supply, and VM is a motor power supply.
- ✓ Make sure that supply voltage does not exceed the absolute MAX ratings under no circumstance. Noncompliance can be the cause of IC destruction and degradation.
- Caution is required for VM supply voltage because this IC performs switching.
- ✓ The bypass capacitor of the VM power supply should be close to the IC as much as possible to stabilize voltage. Also if you intend to use high current or back EMF is high, please augment enough capacitance.

•GND pin [GND, PGND, RNF-resistor GND line]

- High current flows into the PGND and GND side of RNF resistor; therefore, connect PGND and RNF – GND independently.
- On the other hand, since PGND and GND are connected through silicon board, if the line of PGND is too long, difference of electric potential occurs between PGND and GND which creates gradient to the GND electric potential within the IC board. This can be the cause of the IC malfunction. Hence make sure to connect PGND and RNF GND independently so that the pins do not share the common impedance with GND. And GND, PGND, and RNF should be single-point grounded to the low impedance GND area near the IC. Also the capacitor between VM and GND should be connected adjacent to the IC.

Internal power supply regulator pin [REG5]

- ✓ REG5 is a power supply to drive output FET (typ 5V).
- ✓ When VM supply is powered and PS is"High", REG5 operates.
- ✓ Please connect capacitor for stabilize REG5. The recommendation value is 0.1uF.
- ✓ Since the voltage of REG5 fluctuates (±10%), do not use it as reference voltage that requires accuracy.

Input pin

- The logic input pin incorporates pull-down resistor (100kΩ).
- ✓ When you set input pin to low voltage, please short it to GND because the input pin is vulnerable to noise.
- ✓ The input is TTL level (H: 2V or higher, L: 0.8V or lower).
- ✓ VREF pin is high impedance.

•OUT pin [OUT1A, OUT1B, OUT2A, OUT2B]

- During chopping operation, the output voltage becomes equivalent to VM voltage, which can be the cause of noise. Caution is required for the pattern layout of output pin.
- ✓ The layout should be low impedance because driving current of motor flows into the output pin.
- ✓ Output voltage may boost due to back EMF. Make sure that the voltage does not exceed the absolute MAX ratings under no circumstance. Noncompliance can be the cause of IC destruction and degradation.

•Current sense resistor connection pin [RNF1, RNF2]

- ✓ To perform constant current control, please connect resistor to RNF pin.
- ✓ To perform saturation drive (without constant current control) , please connect RNF pin to GND.
- ✓ If RNF pin is open, you cannot set constant current under normal condition. Therefore, please connect it to resistor or GND.
- ✓ The motor current flows into RNF GND line. Therefore, please connect it to common GND line and low impedance line.

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